Spread Spectrum Clock Generator

MB88152

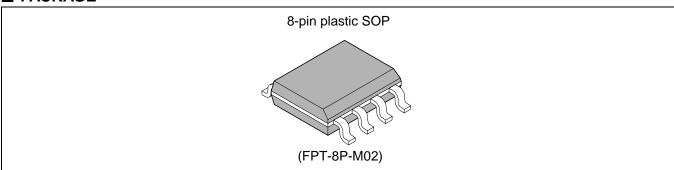
■ DESCRIPTION

MB88152 is a clock generator for EMI reduction. The peak of unnecessary radiation noise (EMI) can be attenuated by making the oscillation frequency slightly modulate periodically with the internal modulator. It corresponds to both of the center spread which modulates input frequency as Middle Centered and down spread which modulates so as not to exceed input frequency.

■ FEATURES

- Input frequency: 20 MHz to 134 MHz
- Output frequency: 20 MHz to 134 MHz
- Modulation rate : $\pm 0.5\%$, $\pm 1.5\%$ (Center spread), -1.0%, -3.0% (Down spread)
- Equipped with crystal oscillation circuit: Range of oscillation 20 MHz to 48 MHz
- Modulation clock output Duty: 40% to 60%
- Modulation clock Cycle-Cycle Jitter: Less than 100 ps
- Low current consumption by CMOS process: 5 mA@24 MHz (Typ-sample, no load)
- Power supply voltage: 3.3 V ± 0.3 V
- Operating temperature : 40 °C to +85 °C
- Package: SOP 8 pin

■ PACKAGE



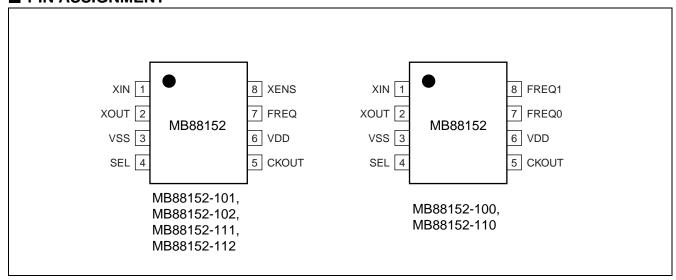


■ PRODUCT LINE-UP

MB88152 has three kinds of input frequency, and two kinds of modulation type (center/down spread), total six line-ups.

Product	Function
MB88152-100	Frequency range from 20 MHz to 134 MHz, Down spread, No enable setting
MB88152-101	Frequency range from 20 MHz to 67 MHz, Down spread, No modulation enable pin
MB88152-102	Frequency range from 40 MHz to 133 MHz, Down spread, Enable setting
MB88152-110	Frequency range from 20 MHz to 134 MHz, Center spread, No modulation enable pin
MB88152-111	Frequency range from 20 MHz to 67 MHz, Center spread, Enable setting
MB88152-112	Frequency range from 40 MHz to 133 MHz, Center spread, Enable setting

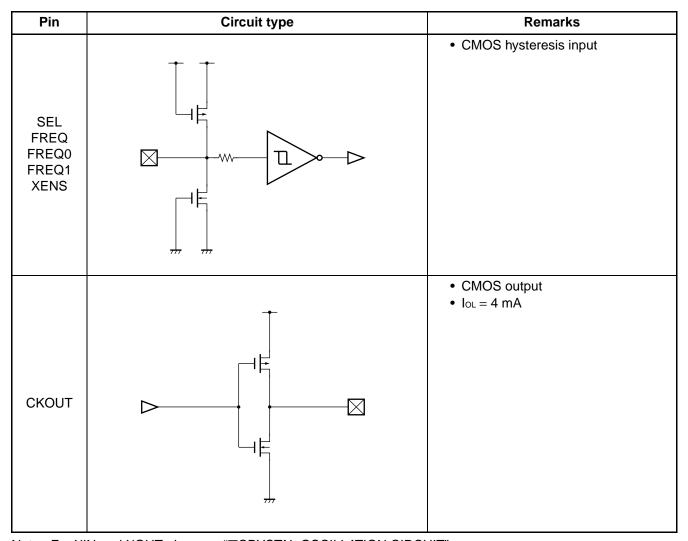
■ PIN ASSIGNMENT



■ PIN DESCRIPTION

Pin name	I/O	Pin no.	Description		
XIN	I	1	Crystal resonator connection Pin/clock input pin		
XOUT	0	2	Crystal resonator connection Pin		
VSS	_	3	GND Pin		
SEL	ļ	4	Modulation rate setting pin		
CKOUT	0	5	Modulated clock output pin		
VDD	_	6	Power supply voltage pin		
FREQ/FREQ0	I	7	Frequency setting pin		
XENS/FREQ1	I	8	Modulation enable setting pin/frequency setting pin		

■ I/O CIRCUIT TYPE



Note: For XIN and XOUT pins, see "■CRYSTAL OSCILLATION CIRCUIT".

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HANDLING DEVICES

Preventing Latchup

A latchup can occur if, on a CMOS IC, a voltage higher than VDD or a voltage lower than VSS is applied to an input or output pin2 or a voltage higher than the rating is applied between VDD and VSS. A latchup, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use a CMOS IC, be very careful not to exceed the maximum rating.

Handling unused pins

Do not leave an unused input pin open, since it may cause a malfunction. Handle by, for example, using a pull-up or pull-down resistor.

The attention when the external clock is used

Input the clock to XIN, and don't connect anything with XOUT you use the external clock.

And please pay attention so that an overshoot and an undershoot do not occur to an input clock of XIN.

Power supply pins

Please connecting to the power supply terminal of this device by as lower impedance as possible from the current supply source.

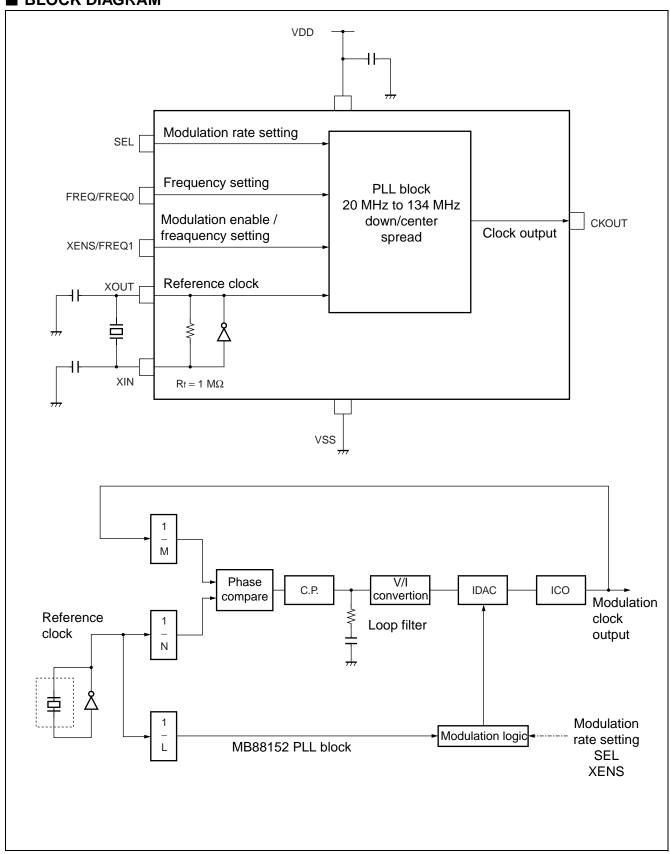
We recommend connecting electrolytic capacitor (about 10 μ F) and the ceramic capacitor (about 0.01 μ F) in parallel between VSS and VDD near the device, as a by - pass capacitor.

Crystal Oscillator Circuit

Noise near the XIN or XOUT pin may cause the device to malfunction. Design printed circuit boards so that electric wiring of XIN and XOUT and crystal resonator (or ceramic resonator) don't intersect other wiring.

It is strongly recommended that printed circuit board artwork that surrounds the XIN and XOUT pins with ground be used to increase the expectation of stable operation.

■ BLOCK DIAGRAM



■ PIN SETTING

When changing the pin setting, the stabilization wait time for the modulation clock is required. The stabilization wait time for the modilation clock takes the maximum value of Lock-Up time in "

ELECTRICAL CHARACTER-ISTICS".

Modulation enable setting

XENS	Modulation					
0	Modulation enable					
1	Modulation disable	MB88152-101, 102, 111, 112				

Note: MB88152-100 and 110 do not have XENS pin.

SEL modulation rate setting

SEL	Modula	Remarks	
0	± 0.5%	MB88152-110, 111, 112	Center spread
U	- 1.0%	MB88152-100, 101, 102	Down spread
1	± 1.5%	MB88152-110, 111, 112	Center spread
	- 3.0%	MB88152-100, 101, 102	Down spread

Note: The modulation rate can be changed at the level of the terminal.

Frequency setting

FREQ	Frequency						
0	20 MHz to 40 MHz	MB88152-101, 111					
	40 MHz to 80 MHz	MB88152-102, 112					
1	33 MHz to 67 MHz	MB88152-101, 111					
	66 MHz to 134 MHz	MB88152-102, 112					

Note: MB88152-100 and 110 do not have FREQ pin.

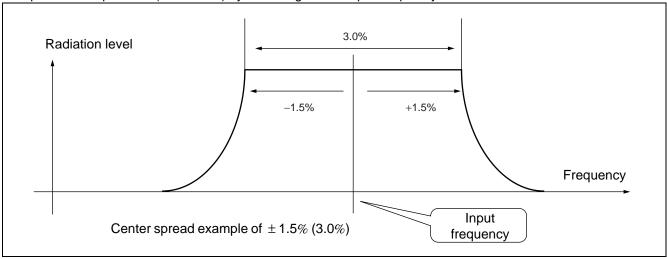
frequency setting

irequeries sen	9							
FREQ1	FREQ0	Frequency						
0	0	20 MHz to 40 MHz						
0	1	33 MHz to 67 MHz	MB88152-100, 110					
1	0	40 MHz to 80 MHz	WIB66132-100, 110					
1	1	66 MHz to 134 MHz						

Note: MB88152-101, 111, 102 and 112 have neither FREQ0 pin nor FREQ1 pin.

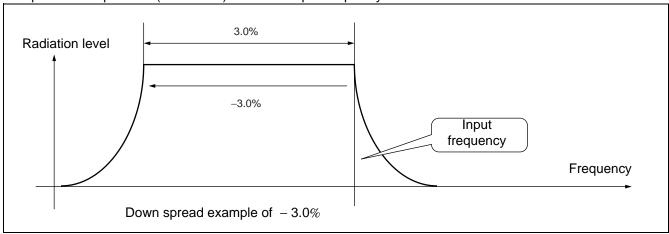
• Center spread

Spectrum is spreaded (modulated) by centering on the input frequency.



• Down spread

Spectrum is spreaded (modulated) below the input frequency.



■ ABSOLUTE MAXIMUM RATINGS

(Vss = 0.0 V)

Parameter	Symbol	Rat	Unit		
Faranieter	Symbol	Min	Max		
Power supply voltage	V _{DD}	- 0.5	+ 4.0	V	
Input voltage	Vı	Vss - 0.5	V _{DD} + 0.5	V	
Output voltage	Vo	Vss - 0.5	V _{DD} + 0.5	V	
Storage temperature	Тѕт	– 55	+ 125	°C	
Operation junction temperature	TJ	- 40	+ 125	°C	
Output voltage	lo	- 14	+ 14	mA	
Overshoot	_	_	V _{DD} + 1.0 (within 50 ns)	V	
Undershoot	_	Vss – 1.0 (within 50 ns)	_	V	

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Doromotor	Cumbal	Din	Conditions		Unit		
Parameter	Symbol	Pin	Conditions	Min	Тур	Max	Unit
Power supply voltage	V _{DD}	VDD	_	3.0	3.3	3.6	V
"H" level input voltage	VIH	SEL FREQ/FREQ0, XENS/FREQ1	_	$V_{DD} \times 0.80$	_	V _{DD} + 0.3	V
Tr level input veltage		XIN	20 MHz to 100 MHz	$V_{DD} \times 0.80$	_	V _{DD} + 0.3	V
			100 MHz to 134 MHz	$V_{\text{DD}} \times 0.90$	_	V _{DD} + 0.3	V
"L" level input voltage	VIL	SEL FREQ/FREQ0, XENS/FREQ1	_	Vss		V _{DD} × 0.20	V
		XIN	20 MHz to 100 MHz	Vss		V _{DD} + 0.20	V
		AIIN	100 MHz to 134 MHz	Vss		V _{DD} + 0.10	V
Input clock	Tpci	XIN	20 MHz to 100 MHz	40	50	60	%
[Duty Cycle]	I DCI	AIN	100 MHz to 134 MHz	45	50	55	70
Operating temperature	Та	_		-40		+ 85	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ ELECTRICAL CHARACTERISTICS

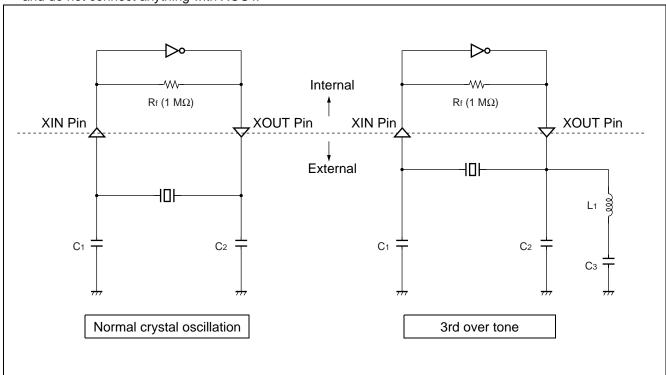
 $(Ta = +25 \, {}^{\circ}C, \, V_{DD} = 3.3V)$

Domester	Sym-		O an dition o	Value			Unit	
Parameter	bol	Pin	Conditions	Min	Тур	Max	Unit	
Power supply current	Icc	VDD	24 MHz output No load capacitance	_	5.0	7.0	mA	
Crystal oscillation frequency	fx	XIN,	Basic wave oscillation	20	_	40	MHz	
Crystal Oscillation frequency	IX	XOUT	3rd over tone	40	_	48		
			MB88152-100, 110	20		134		
Input frequency	fin	XIN	MB88152-101, 111	20	_	67	MHz	
			MB88152-102, 112	40	_	134		
			MB88152-100, 110	20	_	134		
Output frequency	fоит	CKOUT	MB88152-101, 111	20		67	MHz	
			MB88152-102, 112	40		134	-	
_	Vон	CKOLIT	H level output Iон = -4 mA	V _{DD} - 0.5	_	V _{DD}	V	
Output voltage	VoL	CKOUT	L level output IoL = 4 mA	Vss	_	0.4	V	
Output through rate	SR	CKOUT	0.4 V to 2.4 V	0.4		4.0	V/ns	
Output high impedance	Zo	CKOUT	CKOUT 20 MHz to 134 MHz		45	_	Ω	
Output clock Duty Cycle	TDCC	CKOUT	1.5 V	40	_	60	%	
Input capacitance	Cin	XIN SEL FREQ/ FREQ0 XENS/ FREQ1	$Ta = +25 \text{ °C}$ $V_{DD} = V_{I} = 0.0 \text{ V}$ $f = 1 \text{ MHz}$		_	16	pF	
			20 MHz to 67 MHz			15		
Load capacitance	C_L	CKOUT	67 MHz to 100 MHz	_	_	10	pF	
			100 MHz to 134 MHz		_	7		
Modulation cycle	Fмор	CKOUT	_	_	12.5		kHz	
Lock-Up time	TLK	CKOUT	_	_	2	5	ms	
Cycle-cycle jitter	TJC	скоит	No load capacitance			100	ps	

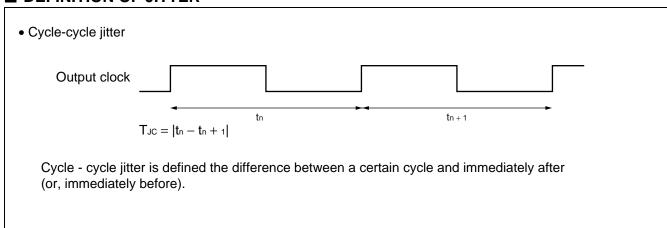
■ CRYSTAL OSCILLATOR CIRCUIT

The left side of figures below shows the connection example about general crystal resonator. The oscillation circuit has the built-in feedback resistanc (1 $M\Omega$). The value of cpacity (C_1 and C_2) is required adjusting to the most suitable value of an individual crystal resonator.

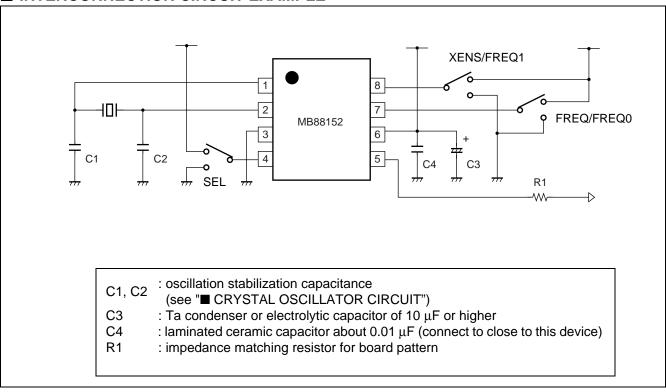
The right side of figures below shows the example of connecting crystal for the 3rd over-tone oscillation. The value of capacity (C_1 , C_2 and C_3) and inductance (L_1) is needed adjusting to the most suitable value of an individual crystal oscillator. When an external clock is used (the crystal resonator is not used) , input the clock to XIN pin and do not connect anything with XOUT.



■ DEFINITION OF JITTER



■ INTERCONNECTION CIRCUIT EXAMPLE

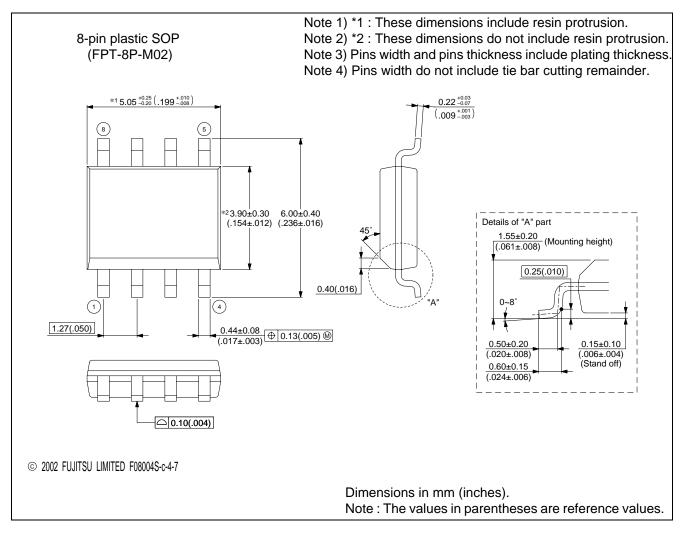


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■ ORDERING INFORMATION

Part number	Frequency	Spread	XENS	Package	Remarks
MB88152PNF-G-100-JNE1	20 MHz to 134 MHz	Down	No		
MB88152PNF-G-101-JNE1	20 MHz to 67 MHz	Down	Yes		
MB88152PNF-G-102-JNE1	40 MHz to 134 MHz	Down	Yes	8-pin plastic SOP	
MB88152PNF-G-110-JNE1	20 MHz to 134 MHz	Center	No	(FPT-8P-M02)	
MB88152PNF-G-111-JNE1	20 MHz to 67 MHz	Center	Yes		
MB88152PNF-G-112-JNE1	40 MHz to 134 MHz	Center	Yes		
MB88152PNF-G-100-JN-EFE1	20 MHz to 134 MHz	Down	No		
MB88152PNF-G-101-JN-EFE1	20 MHz to 67 MHz	Down	Yes		
MB88152PNF-G-102-JN-EFE1	40 MHz to 134 MHz	Down	Yes	8-pin plastic SOP	Embos taping (EF type)
MB88152PNF-G-110-JN-EFE1	20 MHz to 134 MHz	Center	No	(FPT-8P-M02)	
MB88152PNF-G-111-JN-EFE1	20 MHz to 67 MHz	Center	Yes		
MB88152PNF-G-112-JN-EFE1	40 MHz to 134 MHz	Center	Yes		
MB88152PNF-G-100-JN-ERE1	20 MHz to 134 MHz	Down	No		
MB88152PNF-G-101-JN-ERE1	20 MHz to 67 MHz	Down	Yes		
MB88152PNF-G-102-JN-ERE1	40 MHz to 134 MHz	Down	Yes	8-pin plastic SOP	Embos taping
MB88152PNF-G-110-JN-ERE1	20 MHz to 134 MHz	Center	No	(FPT-8P-M02)	(ER type)
MB88152PNF-G-111-JN-ERE1	20 MHz to 67 MHz	Center	Yes		
MB88152PNF-G-112-JN-ERE1	40 MHz to 134 MHz	Center	Yes		

■ PACKAGE DIMENSION



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